
CSE477

VLSI Digital Circuits

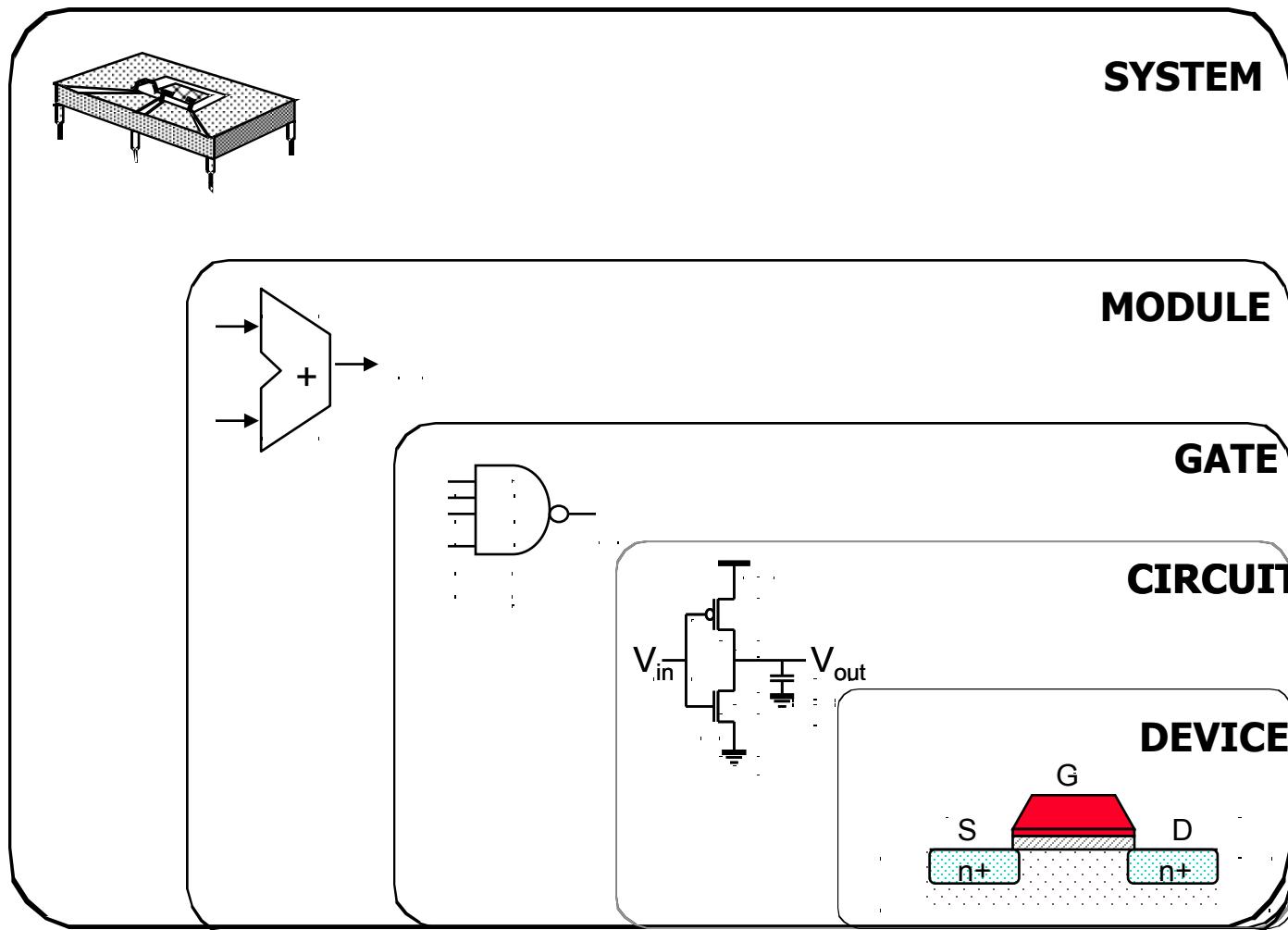
Fall 2002

Lecture 04: CMOS Inverter (static view)

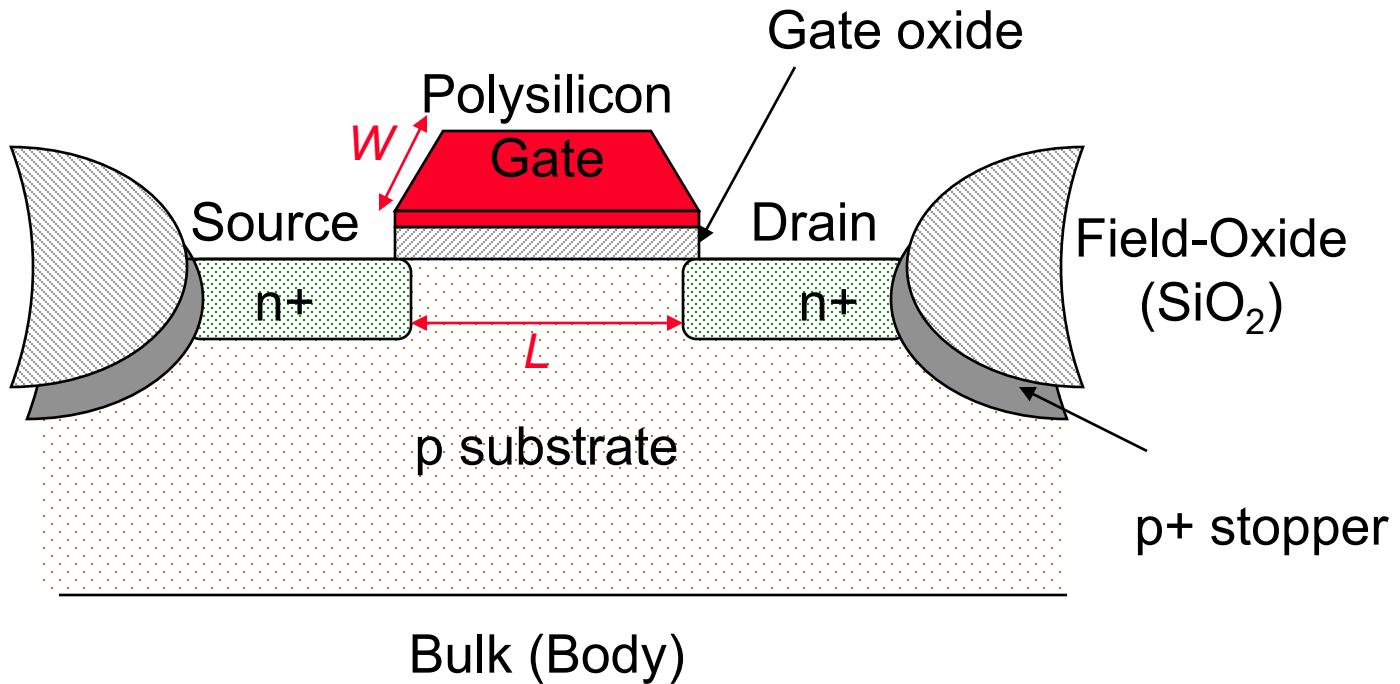
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[Adapted from Rabaey's *Digital Integrated Circuits*, ©2002, J. Rabaey et al.]

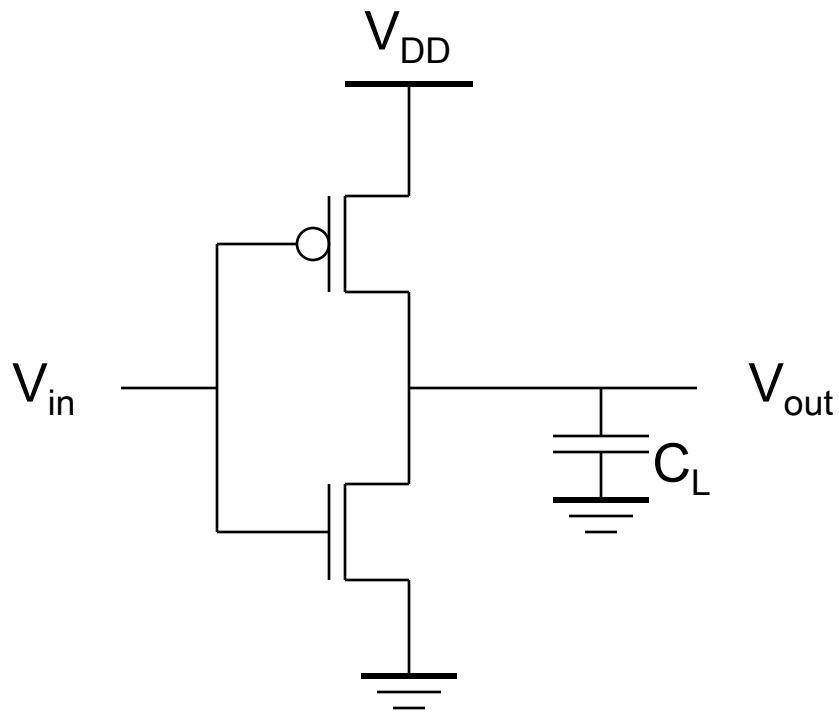
Review: Design Abstraction Levels



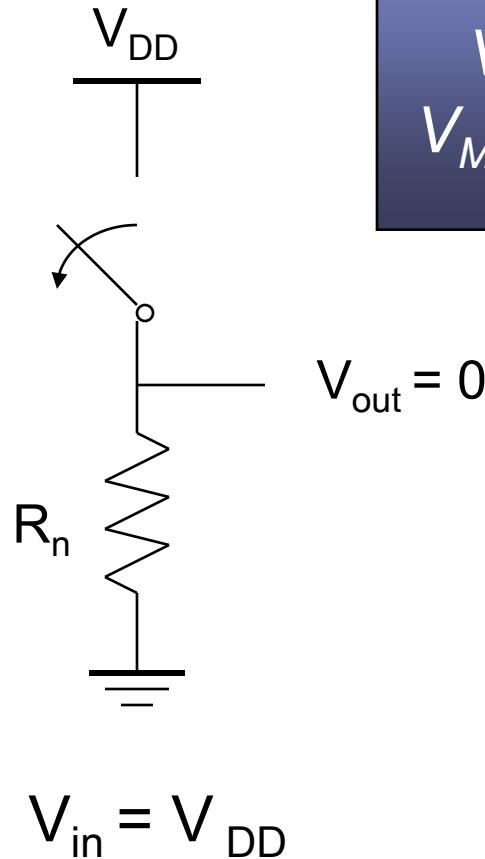
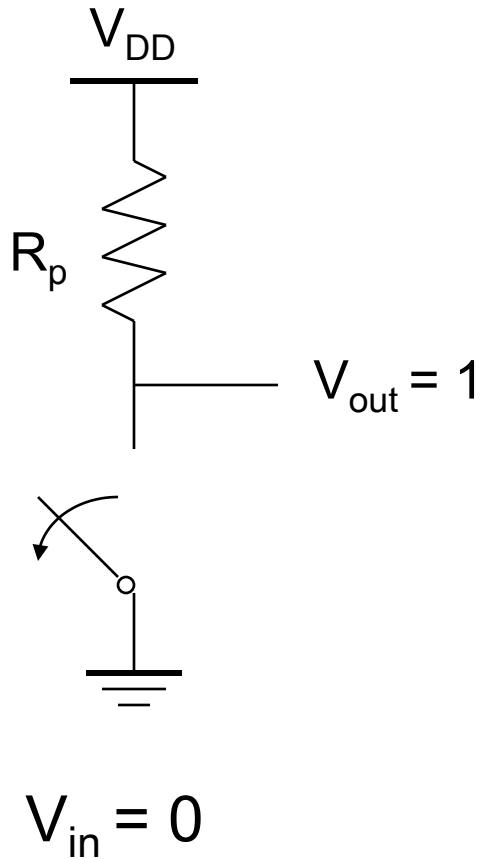
Review: The MOS Transistor



CMOS Inverter: A First Look



CMOS Inverter: Steady State Response

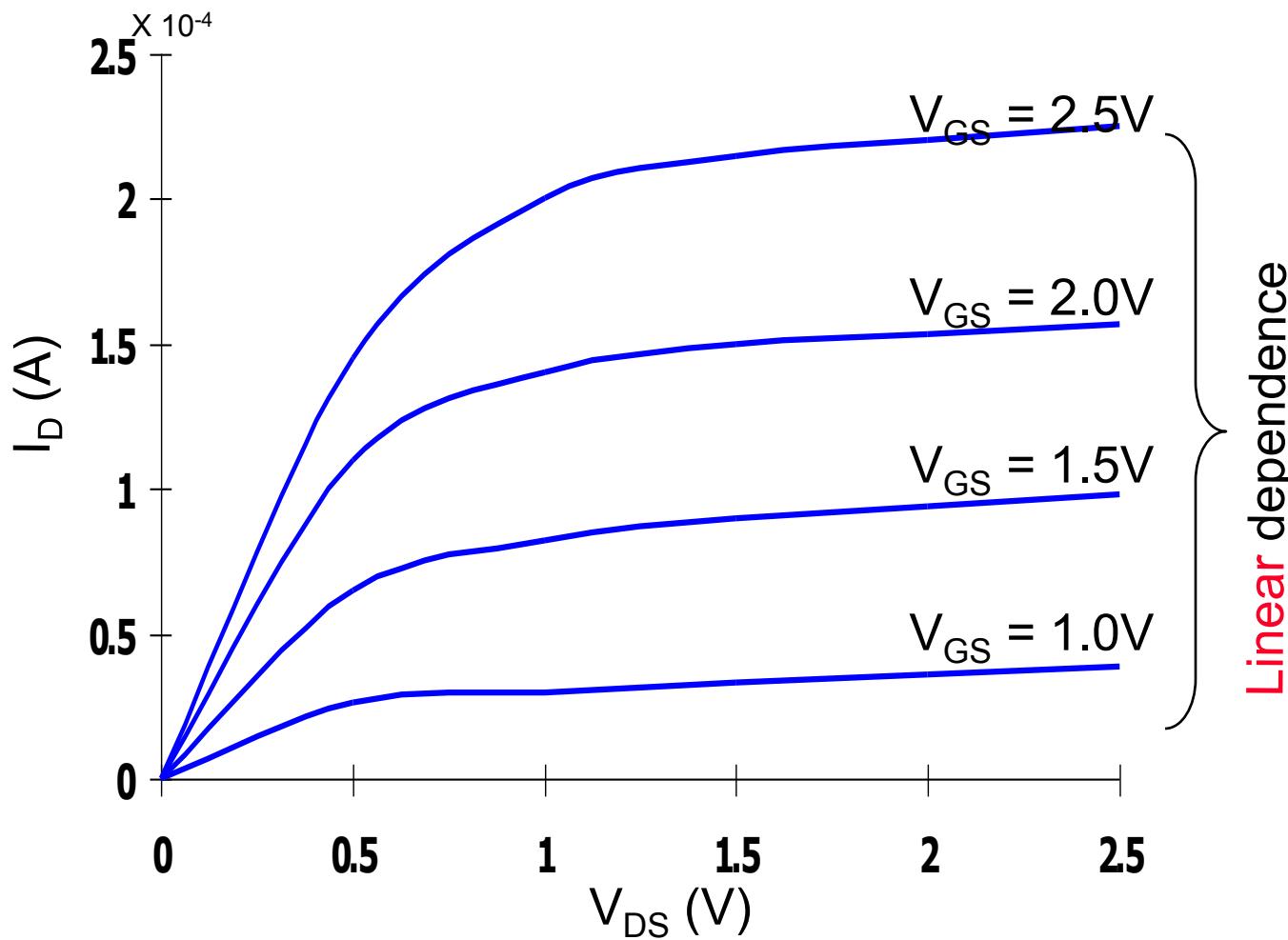


$$V_{OL} = 0$$
$$V_{OH} = V_{DD}$$
$$V_M = f(R_n, R_p)$$

CMOS Properties

- ❑ Full rail-to-rail swing \Rightarrow high noise margins
 - ❑ Logic levels not dependent upon the relative device sizes \Rightarrow transistors can be minimum size \Rightarrow ratioless
- ❑ Always a path to V_{dd} or GND in steady state \Rightarrow low output impedance (output resistance in $k\Omega$ range) \Rightarrow large fan-out (albeit with degraded performance)
- ❑ Extremely high input resistance (gate of MOS transistor is near perfect insulator) \Rightarrow nearly zero steady-state input current
- ❑ No direct path steady-state between power and ground \Rightarrow no static power dissipation
- ❑ Propagation delay function of load capacitance and resistance of transistors

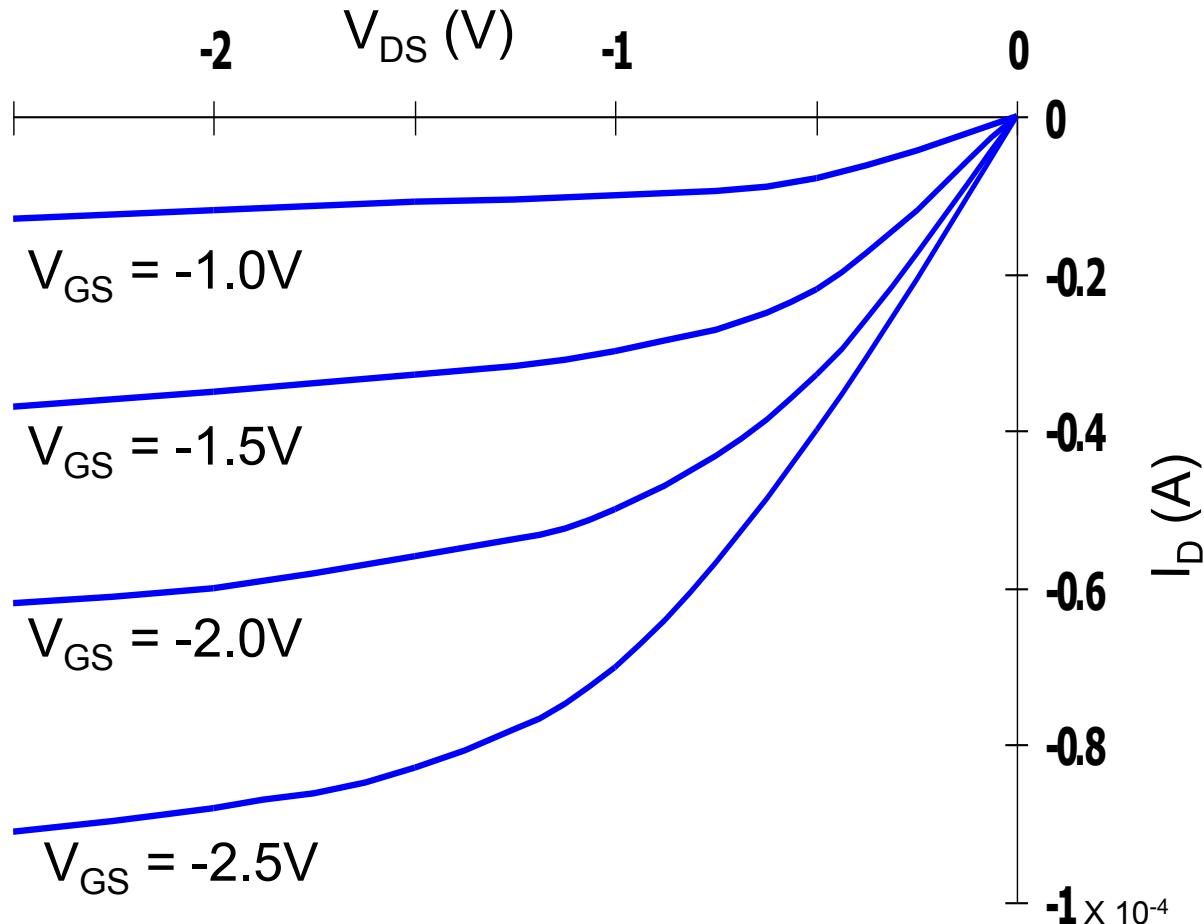
Review: Short Channel I-V Plot (NMOS)



NMOS transistor, 0.25um , $L_d = 0.25\text{um}$, $W/L = 1.5$, $V_{DD} = 2.5\text{V}$, $V_T = 0.4\text{V}$

Review: Short Channel I-V Plot (PMOS)

- All polarities of all voltages and currents are reversed



PMOS transistor, 0.25um, $L_d = 0.25\mu m$, $W/L = 1.5$, $V_{DD} = 2.5V$, $V_T = -0.4V$

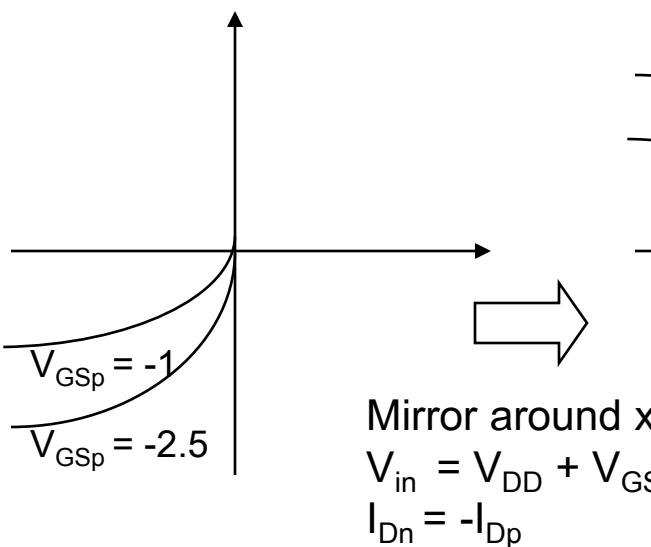
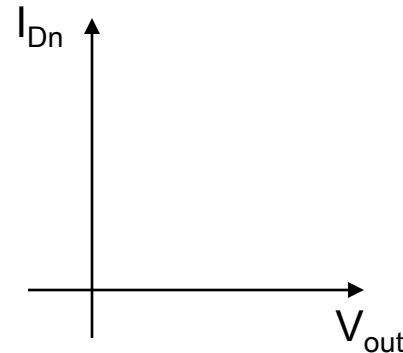
Transforming PMOS I-V Lines

- Want common coordinate set V_{in} , V_{out} , and I_{Dn}

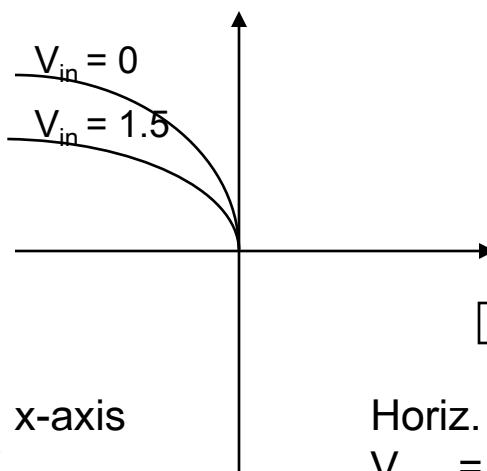
$$I_{DSP} = -I_{DSn}$$

$$V_{GSn} = V_{in} ; V_{GSp} = V_{in} - V_{DD}$$

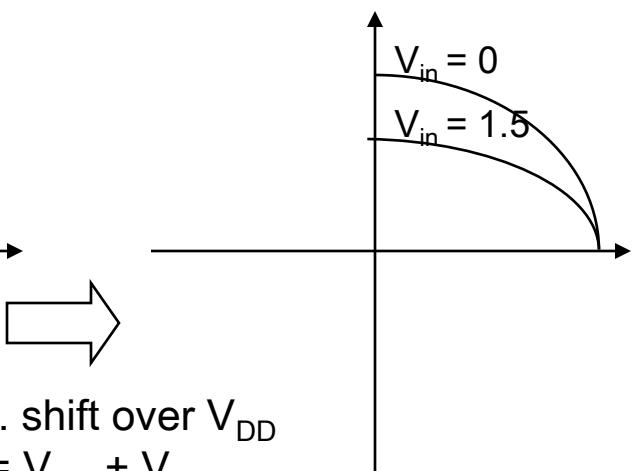
$$V_{DSn} = V_{out} ; V_{DSP} = V_{out} - V_{DD}$$



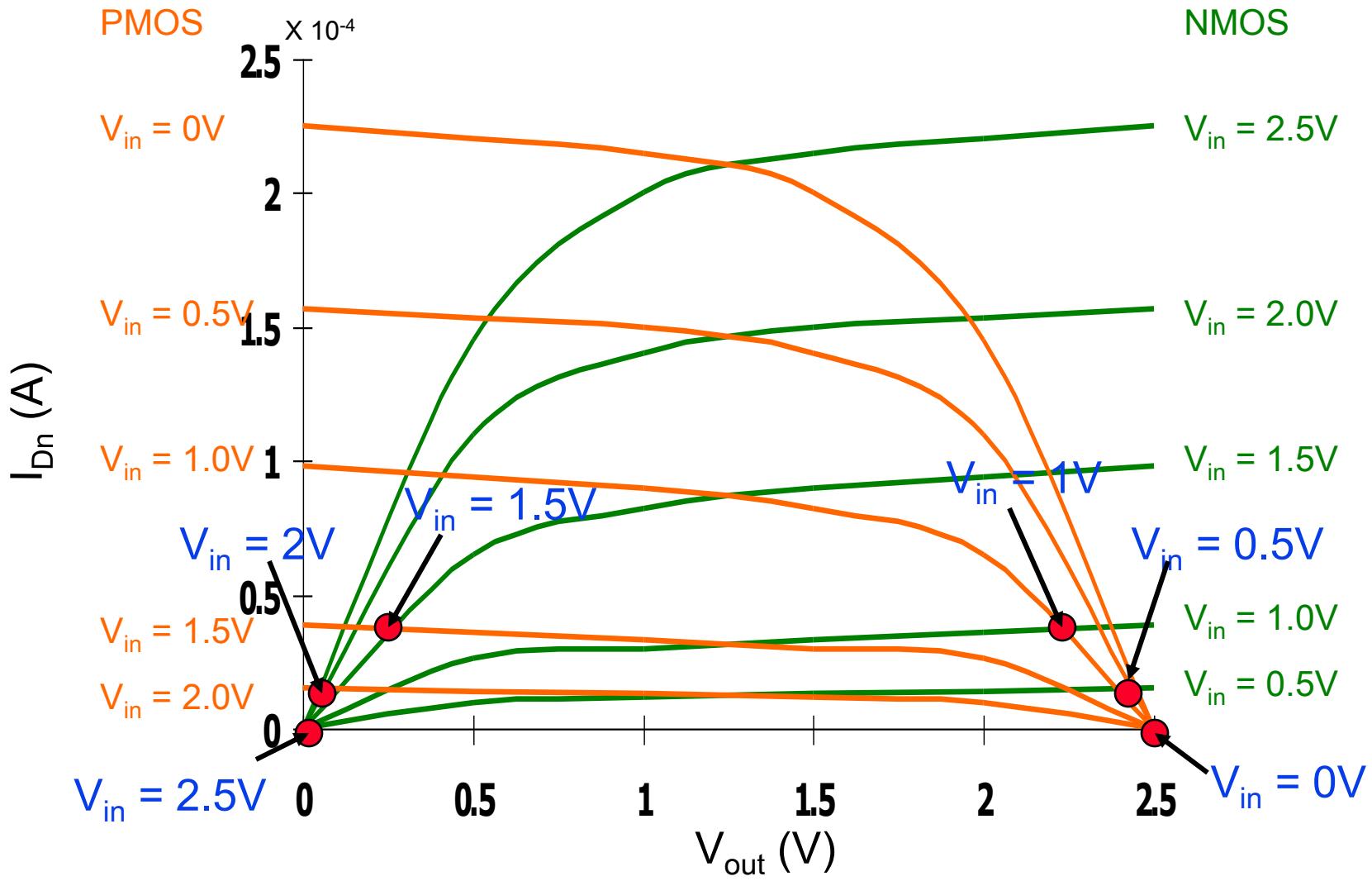
Mirror around x-axis
 $V_{in} = V_{DD} + V_{GSp}$
 $I_{Dn} = -I_{Dp}$



Horiz. shift over V_{DD}
 $V_{out} = V_{DD} + V_{DSP}$

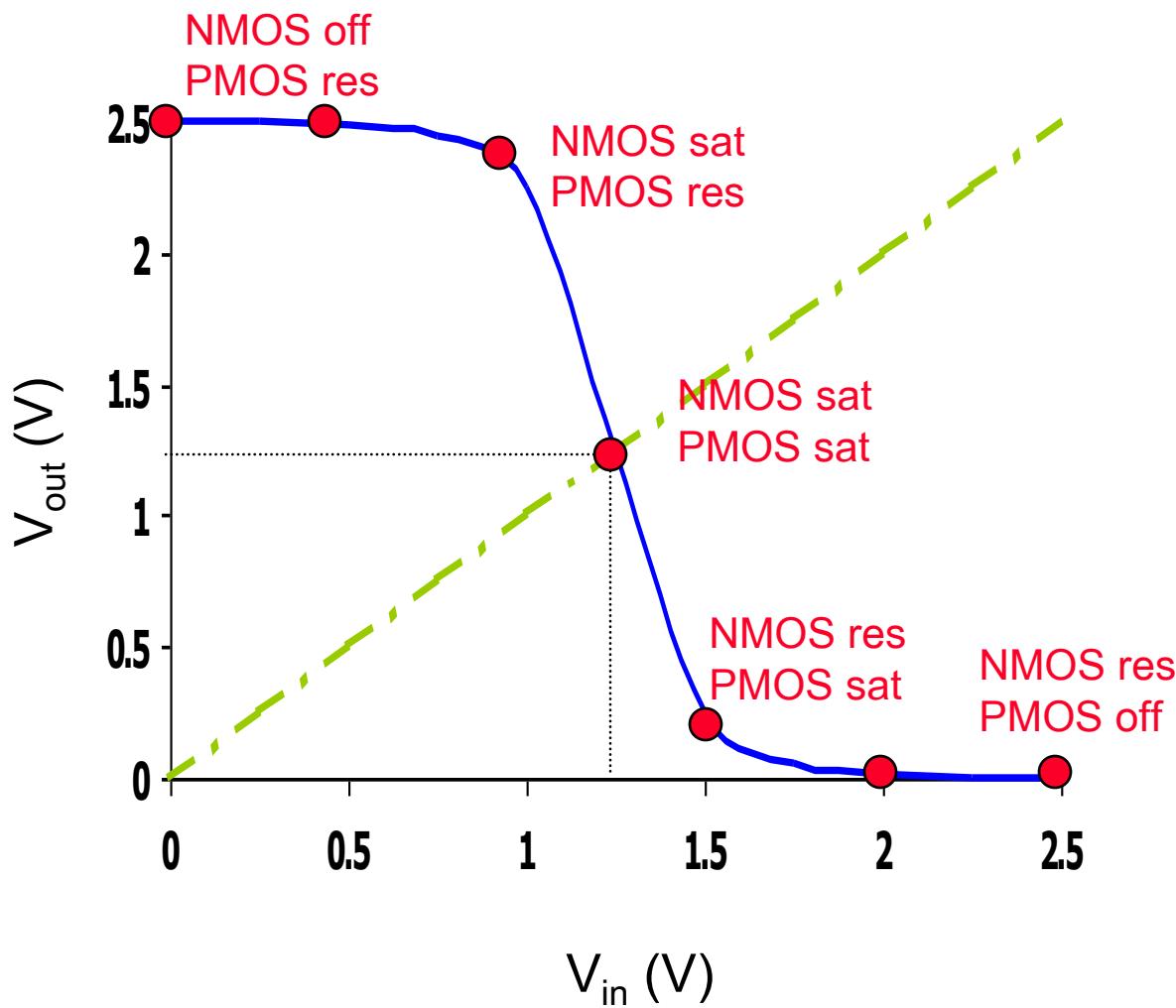


CMOS Inverter Load Lines

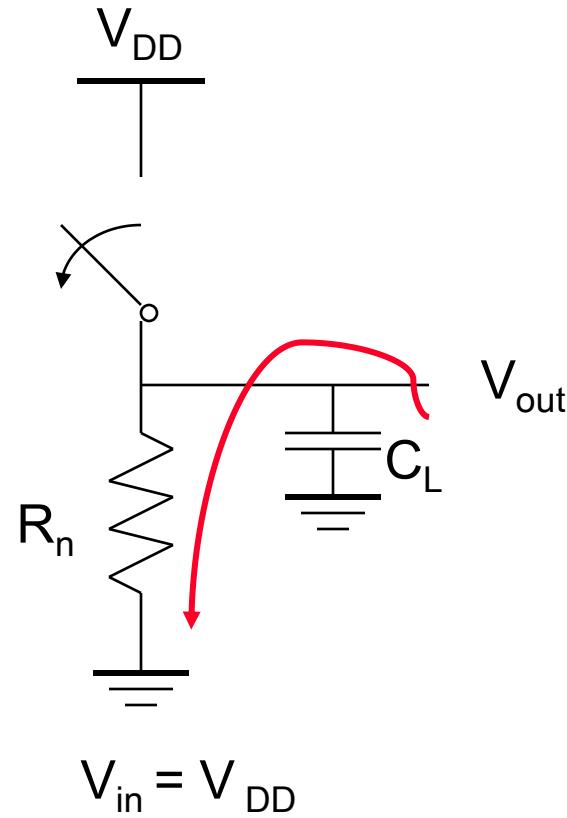
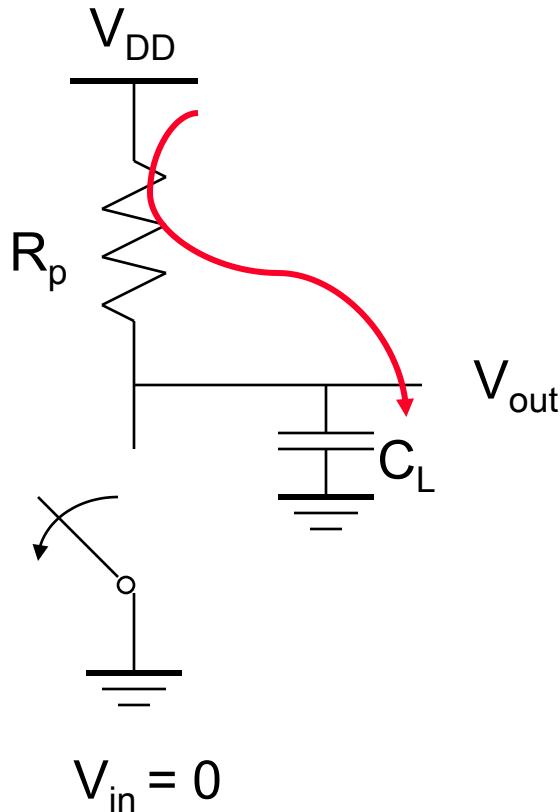


$0.25\mu m, W/L_n = 1.5, W/L_p = 4.5, V_{DD} = 2.5V, V_{Tn} = 0.4V, V_{Tp} = -0.4V$

CMOS Inverter VTC



CMOS Inverter: Switch Model of Dynamic Behavior



- Gate response time is determined by the time to charge C_L through R_p (discharge C_L through R_n)

Relative Transistor Sizing

- ❑ When designing static CMOS circuits, balance the driving strengths of the transistors by making the PMOS section wider than the NMOS section to
 - ❑ maximize the noise margins and
 - ❑ obtain symmetrical characteristics

Switching Threshold

- ❑ V_M where $V_{in} = V_{out}$ (both PMOS and NMOS in saturation since $V_{DS} = V_{GS}$)

$$V_M \approx rV_{DD}/(1 + r) \text{ where } r = k_p V_{DSATp} / k_n V_{DSATn}$$

- ❑ Switching threshold set by the ratio r , which compares the **relative driving strengths** of the PMOS and NMOS transistors
- ❑ Want $V_M = V_{DD}/2$ (to have comparable high and low noise margins), so want $r \approx 1$

$$\frac{(W/L)_p}{(W/L)_n} = \frac{k_n' V_{DSATn} (V_M - V_{Tn} - V_{DSATn}/2)}{k_p' V_{DSATp} (V_{DD} - V_M + V_{Tp} + V_{DSATp}/2)}$$

Switch Threshold Example

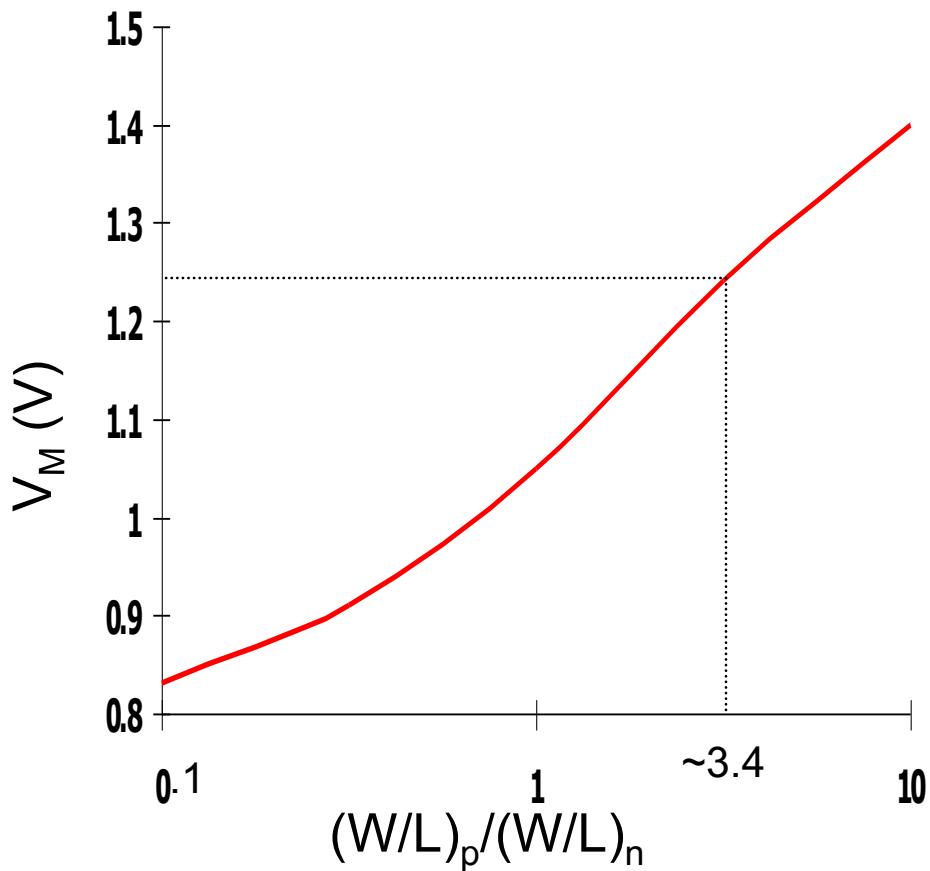
- In our generic 0.25 micron CMOS process, using the process parameters from slide L03.25, a $V_{DD} = 2.5V$, and a minimum size NMOS device ((W/L)_n of 1.5)

	$V_{T0}(V)$	$\gamma(V^{0.5})$	$V_{DSAT}(V)$	$k'(A/V^2)$	$\lambda(V^{-1})$
NMOS	0.43	0.4	0.63	115×10^{-6}	0.06
PMOS	-0.4	-0.4	-1	-30×10^{-6}	-0.1

$$\frac{(W/L)_p}{(W/L)_n} = \frac{115 \times 10^{-6}}{-30 \times 10^{-6}} \times \frac{0.63}{-1.0} \times \frac{(1.25 - 0.43 - 0.63/2)}{(1.25 - 0.4 - 1.0/2)} = 3.5$$

$$(W/L)_p = 3.5 \times 1.5 = 5.25 \text{ for a } V_M \text{ of } 1.25V$$

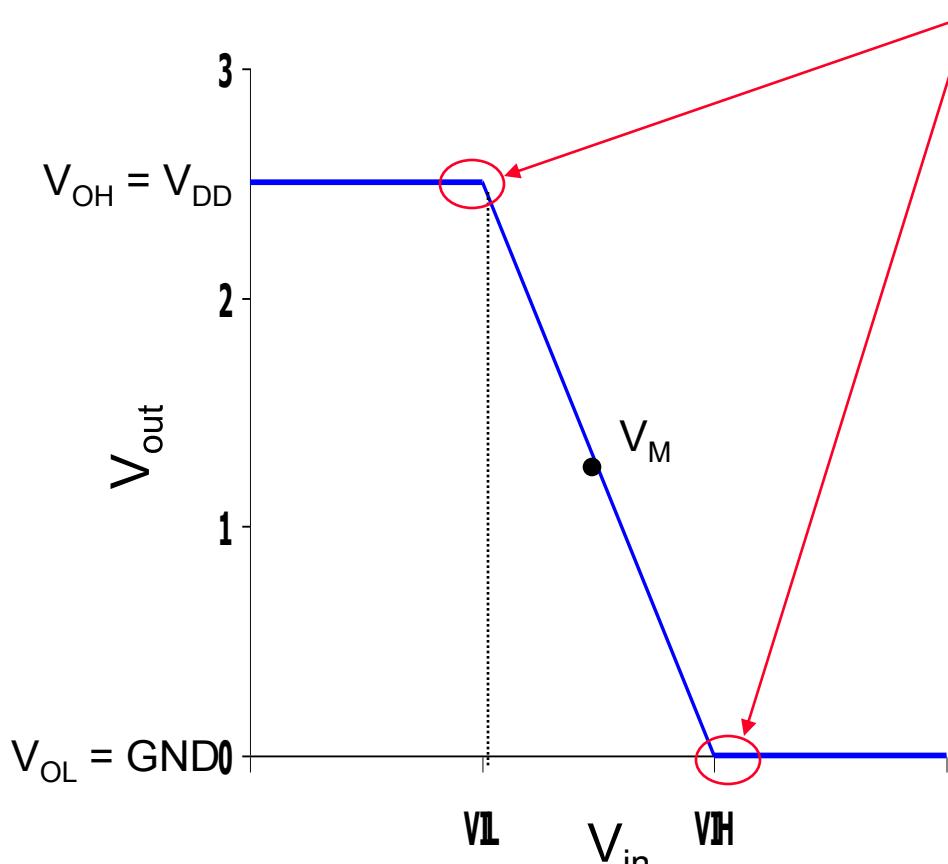
Simulated Inverter V_M



Note: x-axis is semilog

- ❑ V_M is relatively insensitive to variations in device ratio
 - setting the ratio to 3, 2.5 and 2 gives V_M 's of 1.22V, 1.18V, and 1.13V
- ❑ Increasing the width of the PMOS moves V_M towards V_{DD}
- ❑ Increasing the width of the NMOS moves V_M toward GND

Noise Margins Determining V_{IH} and V_{IL}



A piece-wise linear approximation of VTC

By definition, V_{IH} and V_{IL} are where $dV_{out}/dV_{in} = -1$ (= gain)

$$NM_H = V_{DD} - V_{IH}$$
$$NM_L = V_{IL} - GND$$

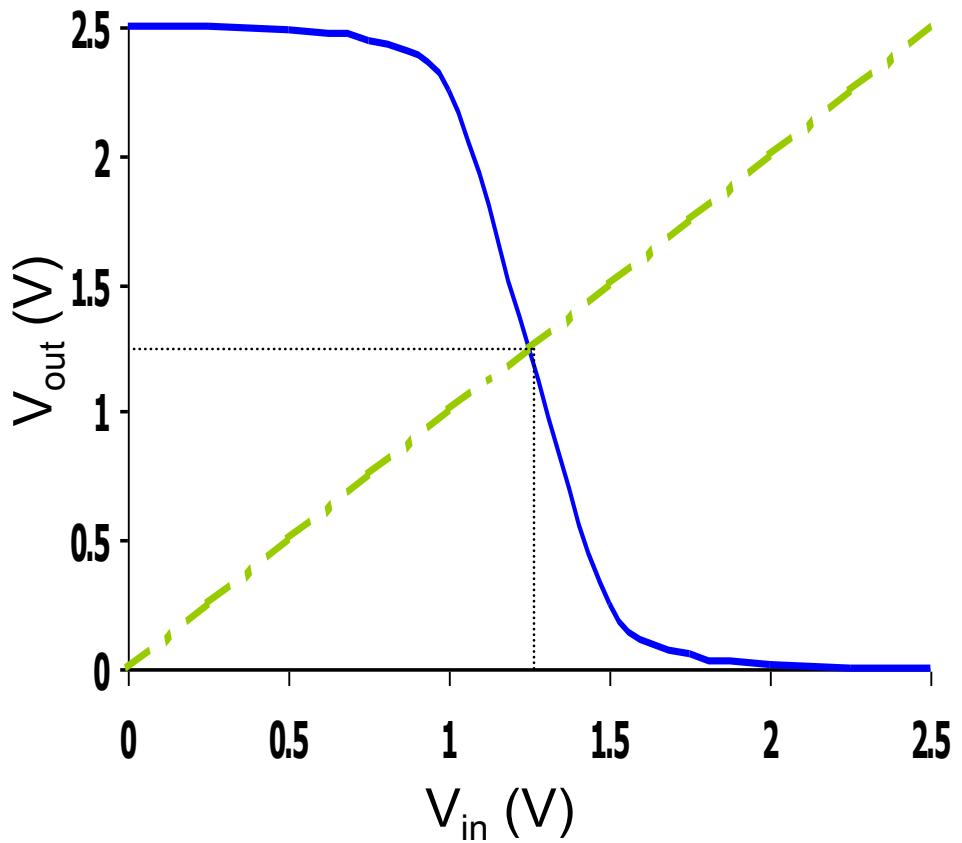
Approximating:

$$V_{IH} = V_M - V_M/g$$

$$V_{IL} = V_M + (V_{DD} - V_M)/g$$

So high gain in the transition region is very desirable

CMOS Inverter VTC from Simulation



$0.25\text{um}, (W/L)_p/(W/L)_n = 3.4$

$(W/L)_n = 1.5$ (min size)

$V_{DD} = 2.5\text{V}$

$V_M \approx 1.25\text{V}, g = -27.5$

$V_{IL} = 1.2\text{V}, V_{IH} = 1.3\text{V}$

$NM_L = NM_H = 1.2$

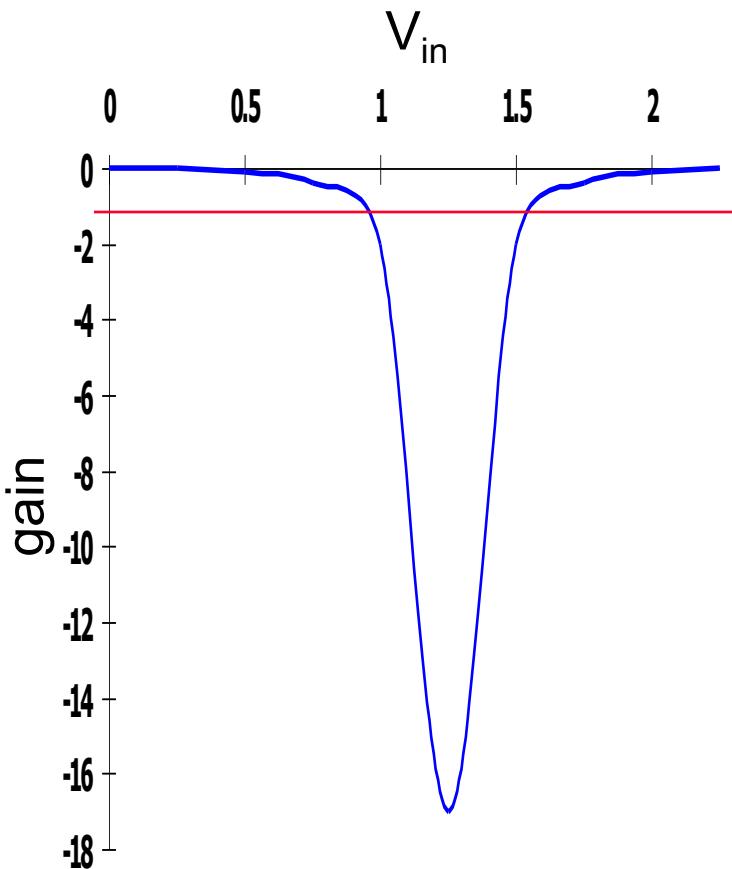
(actual values are

$V_{IL} = 1.03\text{V}, V_{IH} = 1.45\text{V}$

$NM_L = 1.03\text{V} \& NM_H = 1.05\text{V}$)

Output resistance
low-output = $2.4\text{k}\Omega$
high-output = $3.3\text{k}\Omega$

Gain Determinates

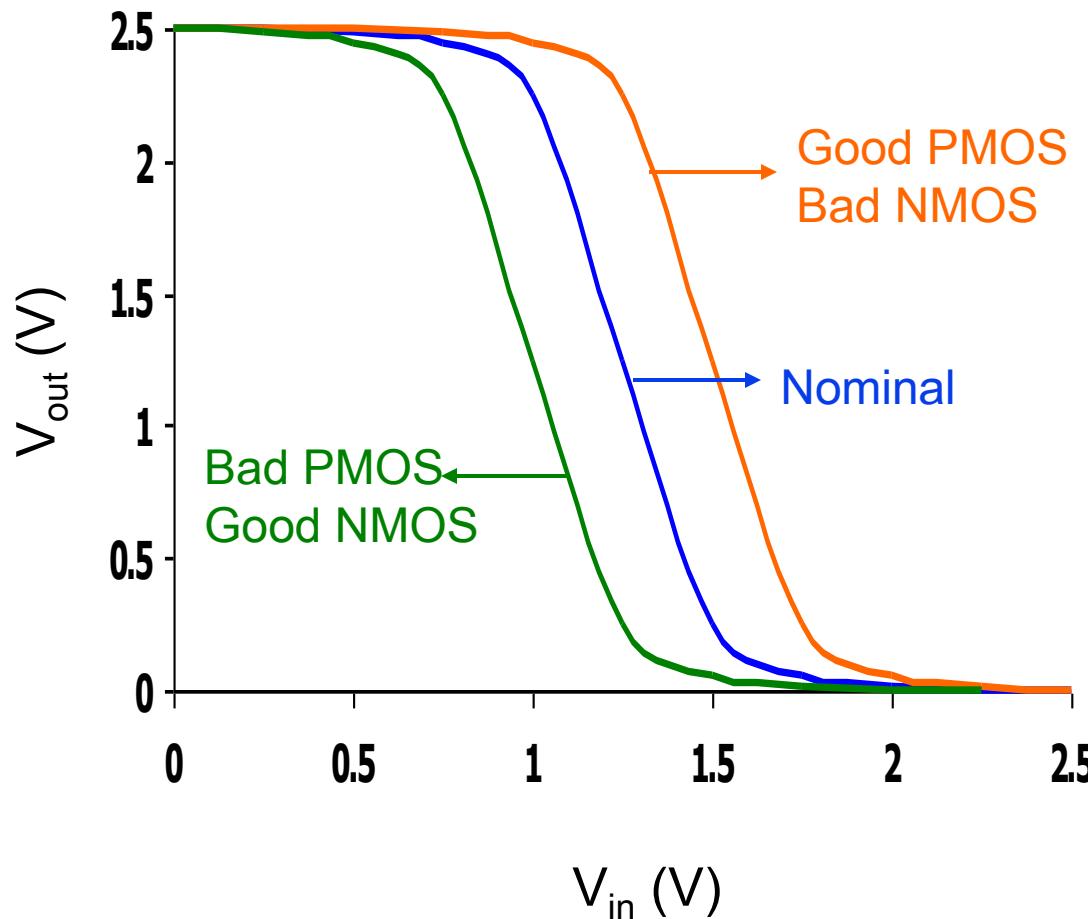


Gain is a strong function of the slopes of the currents in the saturation region, for $V_{in} = V_M$

$$g \approx \frac{(1+r)}{(V_M - V_{Tn} - V_{DSATn}/2)(\lambda_n - \lambda_p)}$$

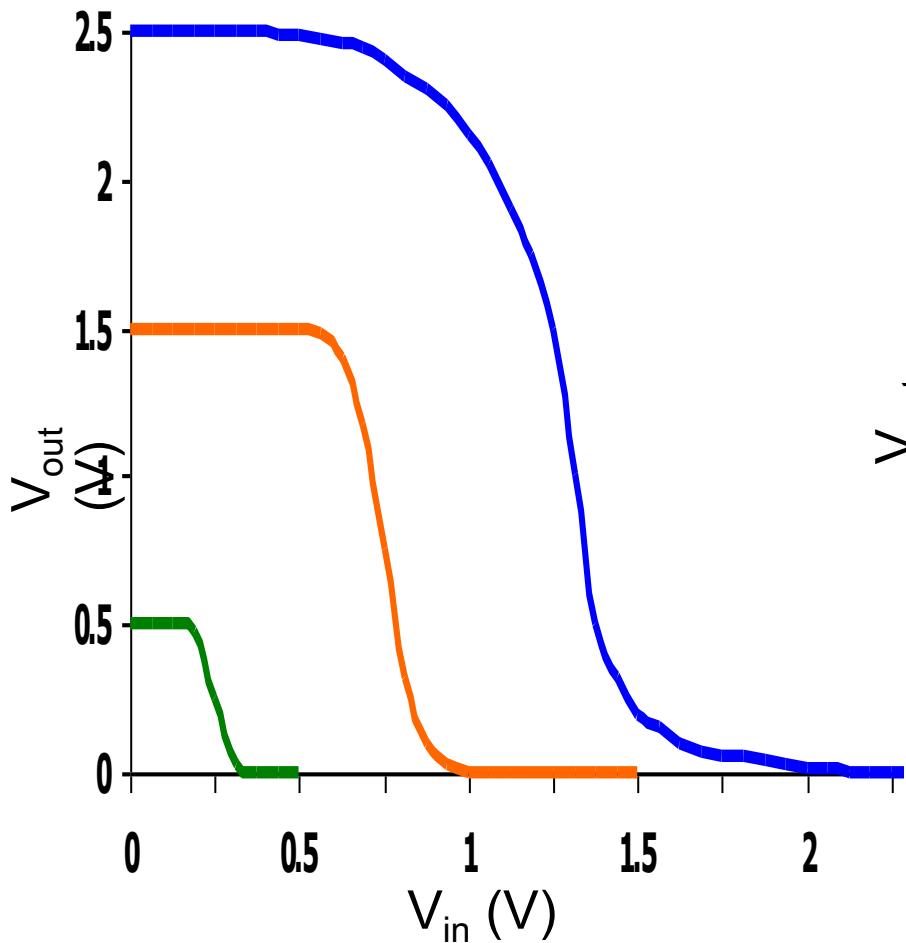
Determined by technology parameters, especially channel length modulation (λ). Only designer influence through **supply voltage** and V_M (**transistor sizing**).

Impact of Process Variation on VTC Curve

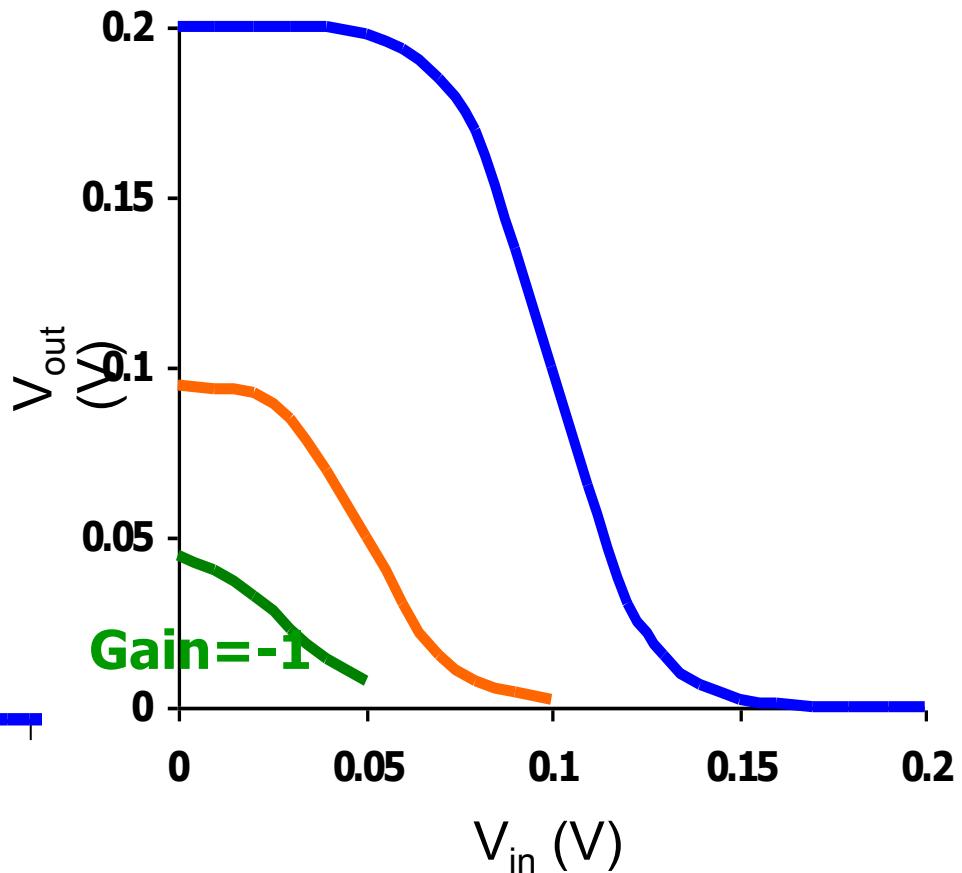


- Process variations (mostly) cause a shift in the switching threshold

Scaling the Supply Voltage

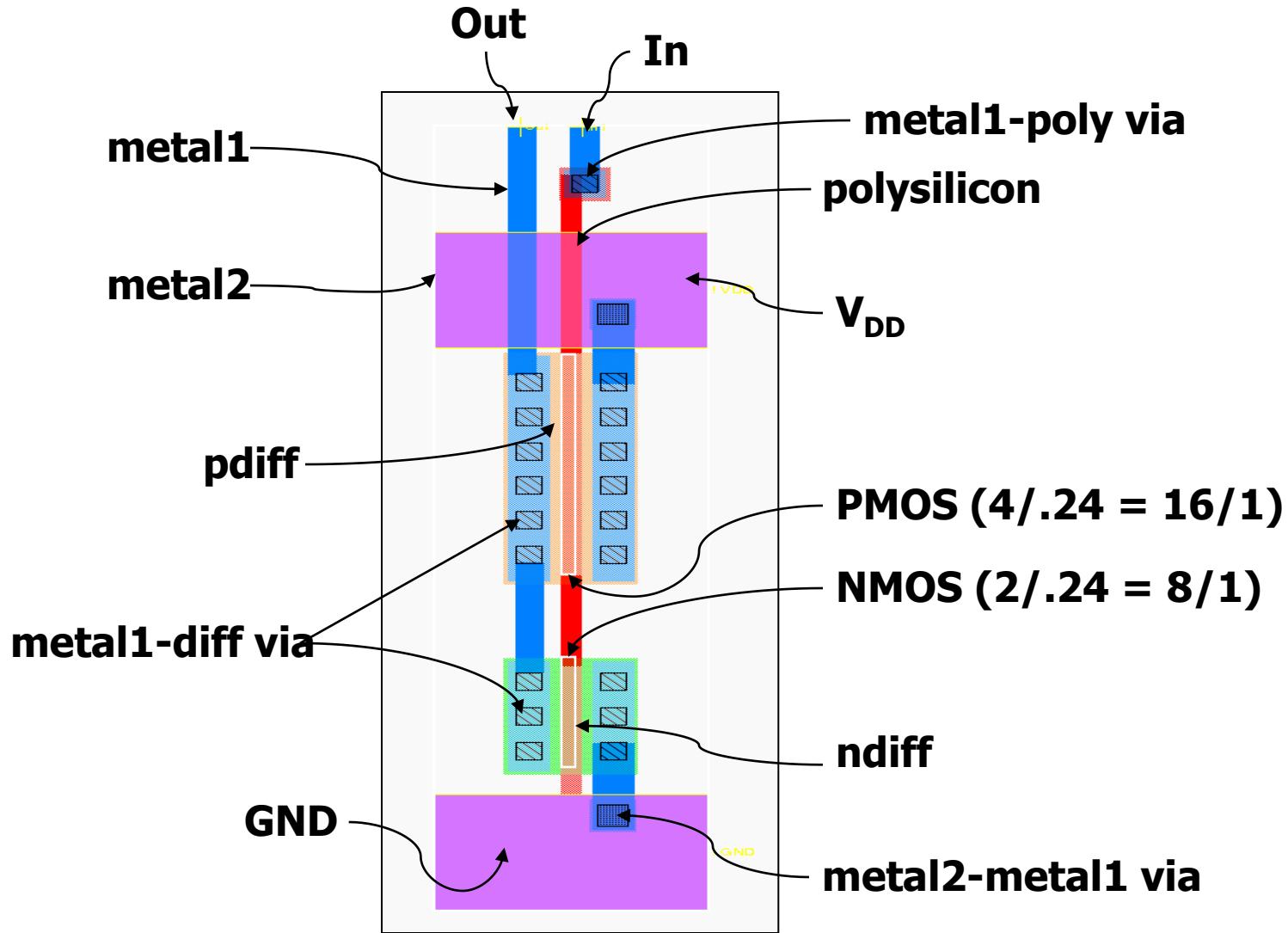


Device threshold voltages are
kept (virtually) constant



Device threshold voltages are
kept (virtually) constant

Next Time: CMOS Inverter *max* Layout



Next Lecture and Reminders

□ Next lecture

- IC manufacturing
 - Reading assignment – Rabaey, et al, 2.1-2.3

□ Reminders

- HW1 due September 10th (next lecture!)
- Project Title due September 12th (one week)
- Evening midterm exam scheduled
 - Wednesday, October 10th from 8:15 to 10:15pm in 260 Willard
 - Only one midterm conflict filed for so far